

DATA SHEET

PCA82C250 CAN controller interface

Preliminary specification
Supersedes data of September 1994
File under Integrated Circuits, IC18

1997 Oct 21

CAN controller interface**PCA82C250****FEATURES**

- Fully compatible with the "ISO/DIS 11898" standard
- High speed (up to 1 Mbaud)
- Bus lines protected against transients in an automotive environment
- Slope control to reduce radio frequency interference (RFI)
- Differential receiver with wide common-mode range for high immunity against electromagnetic interference (EMI)
- Thermally protected
- Short-circuit proof to battery and ground
- Low current standby mode
- An unpowered node does not disturb the bus lines
- At least 110 nodes can be connected.

APPLICATIONS

- High-speed applications (up to 1 Mbaud) in cars.

GENERAL DESCRIPTION

The PCA82C250 is the interface between the CAN protocol controller and the physical bus. The device provides differential transmit capability to the bus and differential receive capability to the CAN controller.

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-------------|---------------------------------|--------------------|------|------|--------------|
| V_{CC} | supply voltage | | 4.5 | 5.5 | V |
| I_{CC} | supply current | | – | 170 | μ A |
| $1/t_{bit}$ | maximum transmission speed | non-return-to-zero | 1 | – | Mbaud |
| V_{CAN} | CANH, CANL input/output voltage | | –8 | +18 | V |
| ΔV | differential bus voltage | | 1.5 | 3.0 | V |
| t_{pd} | propagation delay | high-speed mode | – | 50 | ns |
| T_{amb} | operating ambient temperature | | –40 | +125 | $^{\circ}$ C |

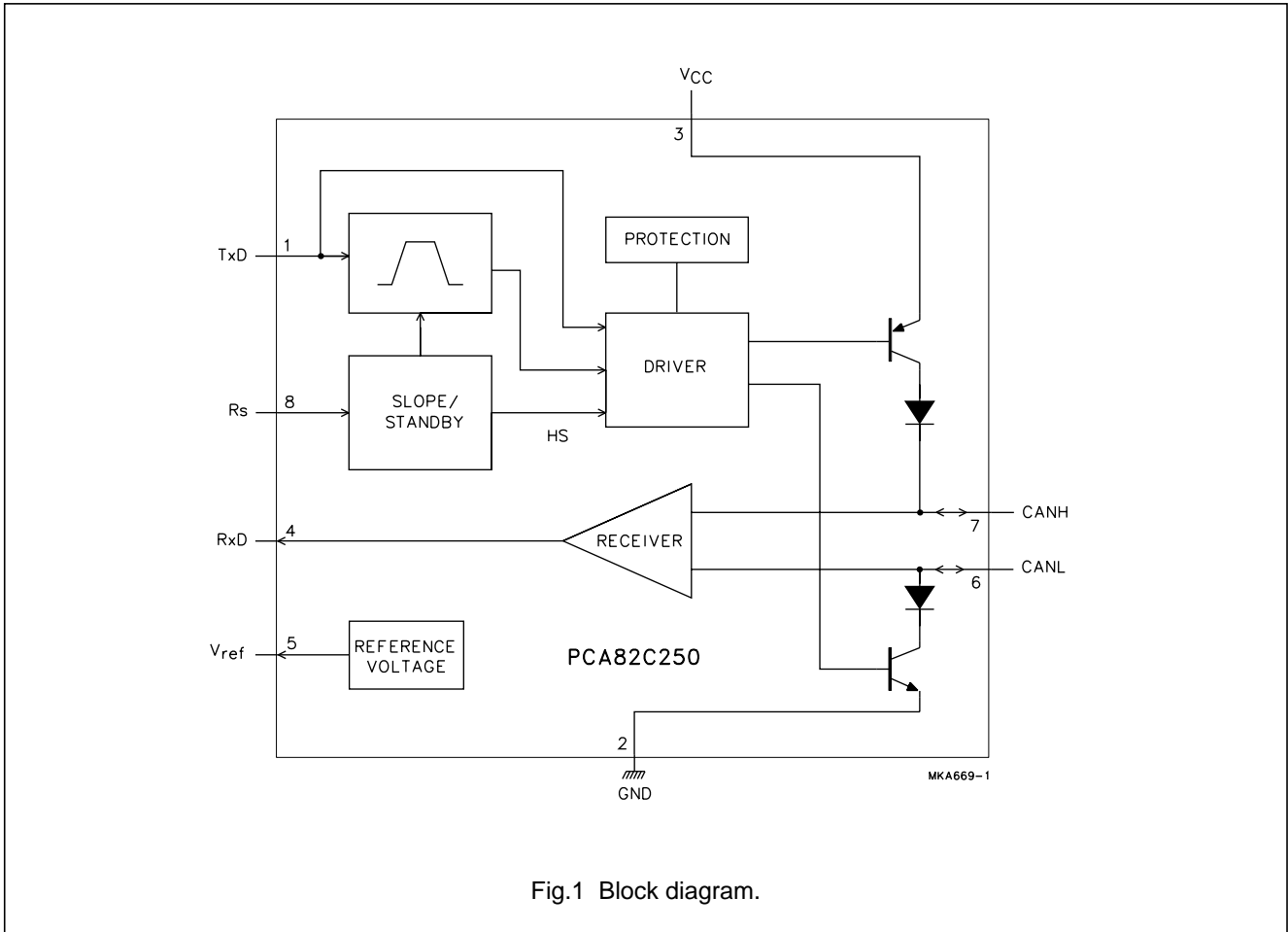
ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | |
|-------------|---------|---|---------|
| | NAME | MATERIAL | CODE |
| PCA82C250 | DIP8 | plastic dual in-line package; 8 leads (300 mil) | SOT97-1 |
| PCA82C250T | SO8 | plastic small outline package; 8 leads; body width 3.9 mm | SOT96-1 |

CAN controller interface

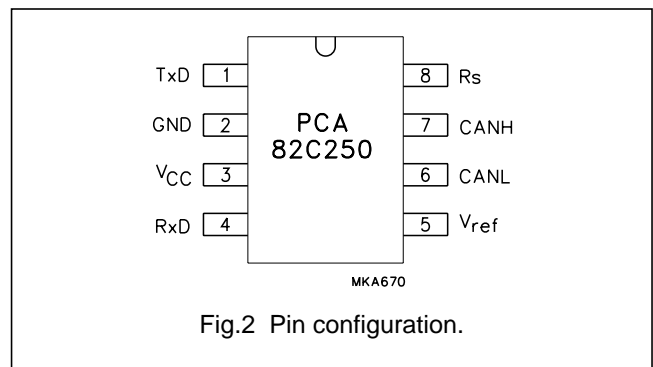
PCA82C250

BLOCK DIAGRAM



PINNING

| SYMBOL | PIN | DESCRIPTION |
|------------------|-----|-------------------------------------|
| TxD | 1 | transmit data input |
| GND | 2 | ground |
| V _{CC} | 3 | supply voltage |
| RxD | 4 | receive data output |
| V _{ref} | 5 | reference voltage output |
| CANL | 6 | LOW level CAN voltage input/output |
| CANH | 7 | HIGH level CAN voltage input/output |
| Rs | 8 | slope resistor input |



CAN controller interface

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FUNCTIONAL DESCRIPTION

The PCA82C250 is the interface between the CAN protocol controller and the physical bus. It is primarily intended for high-speed applications (up to 1 Mbaud) in cars. The device provides differential transmit capability to the bus and differential receive capability to the CAN controller. It is fully compatible with the "ISO/DIS 11898" standard.

A current limiting circuit protects the transmitter output stage against short-circuit to positive and negative battery voltage. Although the power dissipation is increased during this fault condition, this feature will prevent destruction of the transmitter output stage.

If the junction temperature exceeds a value of approximately 160 °C, the limiting current of both transmitter outputs is decreased. Because the transmitter is responsible for the major part of the power dissipation, this will result in a reduced power dissipation and hence a lower chip temperature. All other parts of the IC will remain in operation. The thermal protection is particularly needed when a bus line is short-circuited.

The CANH and CANL lines are also protected against electrical transients which may occur in an automotive environment. Pin 8 (Rs) allows three different modes of operation to be selected: high-speed, slope control or standby.

For high-speed operation, the transmitter output transistors are simply switched on and off as fast as possible. In this mode, no measures are taken to limit the rise and fall slope. Use of a shielded cable is recommended to avoid RFI problems. The high-speed mode is selected by connecting pin 8 to ground.

For lower speeds or shorter bus length, an unshielded twisted pair or a parallel pair of wires can be used for the bus. To reduce RFI, the rise and fall slope should be limited. The rise and fall slope can be programmed with a resistor connected from pin 8 to ground. The slope is proportional to the current output at pin 8.

If a HIGH level is applied to pin 8, the circuit enters a low current standby mode. In this mode, the transmitter is switched off and the receiver is switched to a low current. If dominant bits are detected (differential bus voltage >0.9 V), RxD will be switched to a LOW level. The microcontroller should react to this condition by switching the transceiver back to normal operation (via pin 8). Because the receiver is slow in standby mode, the first message will be lost.

Table 1 Truth table of CAN transceiver

| SUPPLY | TxD | CANH | CANL | BUS STATE | RxD |
|--------------------------------------|-----------------|--------------------------------------|--------------------------------------|-----------|-----|
| 4.5 to 5.5 V | 0 | HIGH | LOW | dominant | 0 |
| 4.5 to 5.5 V | 1 (or floating) | floating | floating | recessive | 1 |
| <2 V (not powered) | X | floating | floating | recessive | X |
| $2\text{ V} < V_{CC} < 4.5\text{ V}$ | $>0.75V_{CC}$ | floating | floating | recessive | X |
| $2\text{ V} < V_{CC} < 4.5\text{ V}$ | X | floating if $V_{Rs} > 0.75V_{CC}$ | floating if $V_{Rs} > 0.75V_{CC}$ | recessive | X |

Table 2 Rs (pin 8) summary

| CONDITION FORCED AT Rs | MODE | RESULTING VOLTAGE OR CURRENT AT Rs |
|---|---------------|------------------------------------|
| $V_{Rs} > 0.75V_{CC}$ | standby | $I_{Rs} < 10\ \mu\text{A} $ |
| $-10\ \mu\text{A} < I_{Rs} < -200\ \mu\text{A}$ | slope control | $0.4V_{CC} < V_{Rs} < 0.6V_{CC}$ |
| $V_{Rs} < 0.3V_{CC}$ | high-speed | $I_{Rs} < -500\ \mu\text{A}$ |

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134). All voltages are referenced to pin 2; positive input current.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------|-----------------------------------|---|------|----------------|------|
| V_{CC} | supply voltage | | -0.3 | +9.0 | V |
| V_n | DC voltage at pins 1, 4, 5 and 8 | | -0.3 | $V_{CC} + 0.3$ | V |
| $V_{6,7}$ | DC voltage at pins 6 and 7 | $0\text{ V} < V_{CC} < 5.5\text{ V}$; no time limit | -8.0 | +18.0 | V |
| V_{trt} | transient voltage at pins 6 and 7 | see Fig.8 | -150 | +100 | V |
| T_{stg} | storage temperature | | -55 | +150 | °C |
| T_{amb} | operating ambient temperature | | -40 | +125 | °C |
| T_{vj} | virtual junction temperature | note 1 | -40 | +150 | °C |

Note

1. In accordance with "IEC 747-1".

An alternative definition of virtual junction temperature T_{vj} is: $T_{vj} = T_{amb} + P_d \times R_{th\ vj-amb}$,
where $R_{th\ vj-amb}$ is a fixed value to be used for the calculation of T_{vj} .

The rating for T_{vj} limits the allowable combinations of power dissipation (P_d) and ambient temperature (T_{amb}).

HANDLING

Classification A: human body model; C = 100 pF; R = 1500 Ω ; V = ± 2000 V.

Classification B: machine model; C = 200 pF; R = 25 Ω ; V = ± 200 V.

QUALITY SPECIFICATION

Quality specification "SNW-FQ-611 part E" is applicable and can be found in the "Quality reference pocket-book" (ordering number 9398 510 34011).

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|-------------|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient | in free air | | |
| | PCA82C250 | | 100 | K/W |
| | PCA82C250T | | 160 | K/W |

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CHARACTERISTICS

$V_{CC} = 4.5$ to 5.5 V; $T_{amb} = -40$ to $+125$ °C; $R_L = 60$ Ω; $I_B > -10$ μA; unless otherwise specified.

All voltages referenced to ground (pin 2); positive input current; all parameters are guaranteed over the ambient temperature range by design, but only 100% tested at $+25$ °C.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|-------------|------|----------------|------|
| Supply | | | | | | |
| I_3 | supply current | dominant; $V_1 = 1$ V | – | – | 70 | mA |
| | | recessive; $V_1 = 4$ V; $R_8 = 47$ kΩ | – | – | 14 | mA |
| | | recessive; $V_1 = 4$ V; $V_8 = 1$ V | – | – | 18 | mA |
| | | standby; $T_{amb} < 90$ °C; note 1 | – | 100 | 170 | μA |
| DC bus transmitter | | | | | | |
| V_{IH} | HIGH level input voltage | output recessive | $0.7V_{CC}$ | – | $V_{CC} + 0.3$ | V |
| V_{IL} | LOW level input voltage | output dominant | –0.3 | – | $0.3V_{CC}$ | V |
| I_{IH} | HIGH level input current | $V_1 = 4$ V | –200 | – | +30 | μA |
| I_{IL} | LOW level input voltage | $V_1 = 1$ V | 100 | – | 600 | μA |
| $V_{6,7}$ | recessive bus voltage | $V_1 = 4$ V; no load | 2.0 | – | 3.0 | V |
| I_{LO} | off-state output leakage current | -2 V $< (V_6, V_7) < 7$ V | –2 | – | +1 | mA |
| | | -5 V $< (V_6, V_7) < 18$ V | –5 | – | +12 | mA |
| V_7 | CANH output voltage | $V_1 = 1$ V | 2.75 | – | 4.5 | V |
| V_6 | CANL output voltage | $V_1 = 1$ V | 0.5 | – | 2.25 | V |
| $\Delta V_{6,7}$ | difference between output voltage at pins 6 and 7 | $V_1 = 1$ V | 1.5 | – | 3.0 | V |
| | | $V_1 = 1$ V; $R_L = 45$ Ω; $V_{CC} \geq 4.9$ V | 1.5 | – | – | V |
| | | $V_1 = 4$ V; no load | –500 | – | +50 | mV |
| I_{sc7} | short-circuit CANH current | $V_7 = -5$ V; $V_{CC} \leq 5$ V | – | – | 105 | mA |
| | | $V_7 = -5$ V; $V_{CC} = 5.5$ V | – | – | 120 | mA |
| I_{sc6} | short-circuit CANL current | $V_6 = 18$ V | – | – | 160 | mA |
| DC bus receiver: $V_1 = 4$ V; pins 6 and 7 externally driven; -2 V $< (V_6, V_7) < 7$ V; unless otherwise specified | | | | | | |
| $V_{diff(r)}$ | differential input voltage (recessive) | | –1.0 | – | +0.5 | V |
| | | -7 V $< (V_6, V_7) < 12$ V; not standby mode | –1.0 | – | +0.4 | V |
| $V_{diff(d)}$ | differential input voltage (dominant) | | 0.9 | – | 5.0 | V |
| | | -7 V $< (V_6, V_7) < 12$ V; not standby mode | 1.0 | – | 5.0 | V |
| $V_{diff(hys)}$ | differential input hysteresis | see Fig.5 | – | 150 | – | mV |
| V_{OH} | HIGH level output voltage (pin 4) | $I_4 = -100$ μA | $0.8V_{CC}$ | – | V_{CC} | V |
| V_{OL} | LOW level output voltage (pin 4) | $I_4 = 1$ mA | 0 | – | $0.2V_{CC}$ | V |
| | | $I_4 = 10$ mA | 0 | – | 1.5 | V |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------------------------|---------------------------------------|--|--------------|------|--------------|------------------------|
| R_i | CANH and CANL input resistance | | 5 | – | 25 | $k\Omega$ |
| R_{diff} | differential input resistance | | 20 | – | 100 | $k\Omega$ |
| C_i | CANH, CANL input capacitance | | – | – | 20 | pF |
| C_{diff} | differential input capacitance | | – | – | 10 | pF |
| Reference output | | | | | | |
| V_{ref} | reference output voltage | $V_8 = 1\text{ V};$ $-50\ \mu\text{A} < I_5 < 50\ \mu\text{A}$ | $0.45V_{CC}$ | – | $0.55V_{CC}$ | V |
| | | $V_8 = 4\text{ V};$ $-5\ \mu\text{A} < I_5 < 5\ \mu\text{A}$ | $0.4V_{CC}$ | – | $0.6V_{CC}$ | V |
| Timing (see Figs 4, 6 and 7) | | | | | | |
| t_{bit} | minimum bit time | $V_8 = 1\text{ V}$ | – | – | 1 | μs |
| t_{onTxD} | delay TxD to bus active | $V_8 = 1\text{ V}$ | – | – | 50 | ns |
| t_{offTxD} | delay TxD to bus inactive | $V_8 = 1\text{ V}$ | – | 40 | 80 | ns |
| t_{onRxD} | delay TxD to receiver active | $V_8 = 1\text{ V}$ | – | 55 | 120 | ns |
| t_{offRxD} | delay TxD to receiver inactive | $V_8 = 1\text{ V}; V_{CC} < 5.1\text{ V};$ $T_{amb} < +85\text{ }^\circ\text{C}$ | – | 82 | 150 | ns |
| | | $V_8 = 1\text{ V}; V_{CC} < 5.1\text{ V};$ $T_{amb} < +125\text{ }^\circ\text{C}$ | – | 82 | 170 | ns |
| | | $V_8 = 1\text{ V}; V_{CC} < 5.5\text{ V};$ $T_{amb} < +85\text{ }^\circ\text{C}$ | – | 90 | 170 | ns |
| | | $V_8 = 1\text{ V}; V_{CC} < 5.5\text{ V};$ $T_{amb} < +125\text{ }^\circ\text{C}$ | – | 90 | 190 | ns |
| t_{onRxD} | delay TxD to receiver active | $R_8 = 47\text{ k}\Omega$ | – | 390 | 520 | ns |
| | | $R_8 = 24\text{ k}\Omega$ | – | 260 | 320 | ns |
| t_{offRxD} | delay TxD to receiver inactive | $R_8 = 47\text{ k}\Omega$ | – | 260 | 450 | ns |
| | | $R_8 = 24\text{ k}\Omega$ | – | 210 | 320 | ns |
| $ SR $ | differential output voltage slew rate | $R_8 = 47\text{ k}\Omega$ | – | 14 | – | $\text{V}/\mu\text{s}$ |
| t_{WAKE} | wake-up time from standby (via pin 8) | | – | – | 20 | μs |
| t_{dRxDL} | bus dominant to RxD LOW | $V_8 = 4\text{ V};$ standby mode | – | – | 3 | μs |
| Standby/slope control (pin 8) | | | | | | |
| V_8 | input voltage for high-speed | | – | – | $0.3V_{CC}$ | V |
| I_8 | input current for high-speed | $V_8 = 0\text{ V}$ | – | – | –500 | μA |
| V_{stb} | input voltage for standby mode | | $0.75V_{CC}$ | – | – | V |
| I_{slope} | slope control mode current | | –10 | – | –200 | μA |
| V_{slope} | slope control mode voltage | | $0.4V_{CC}$ | – | $0.6V_{CC}$ | V |

Note

- $I_1 = I_4 = I_5 = 0\text{ mA}; 0\text{ V} < V_6 < V_{CC}; 0\text{ V} < V_7 < V_{CC}; V_8 = V_{CC}.$

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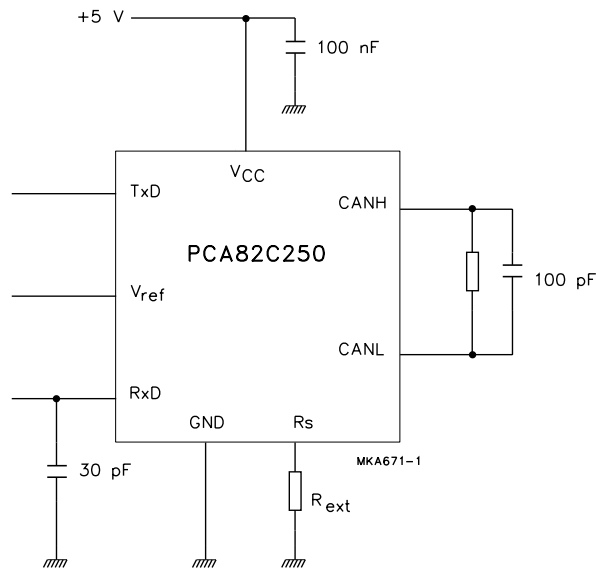


Fig.3 Test circuit for characteristics.

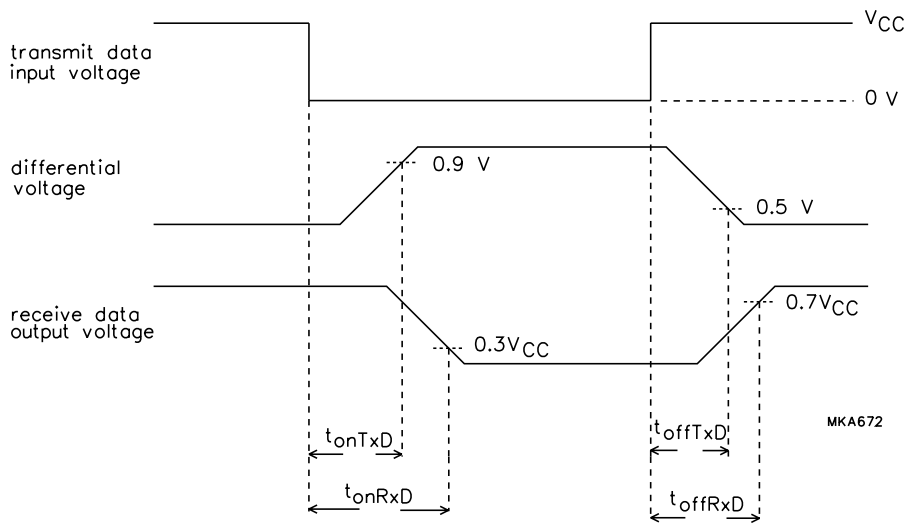


Fig.4 Timing diagram for dynamic characteristics.

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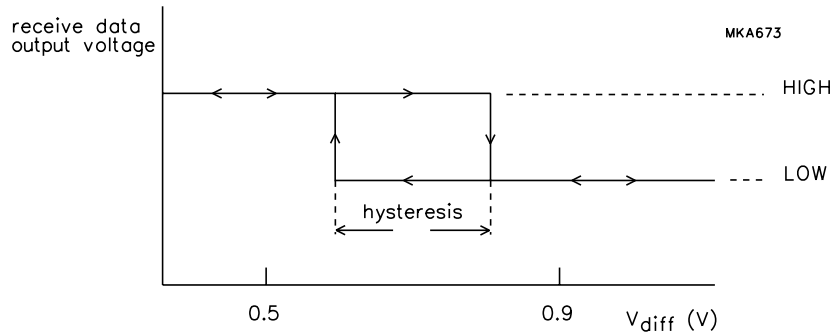
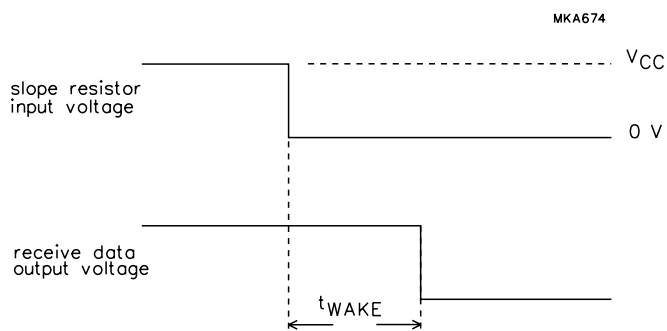


Fig.5 Hysteresis.

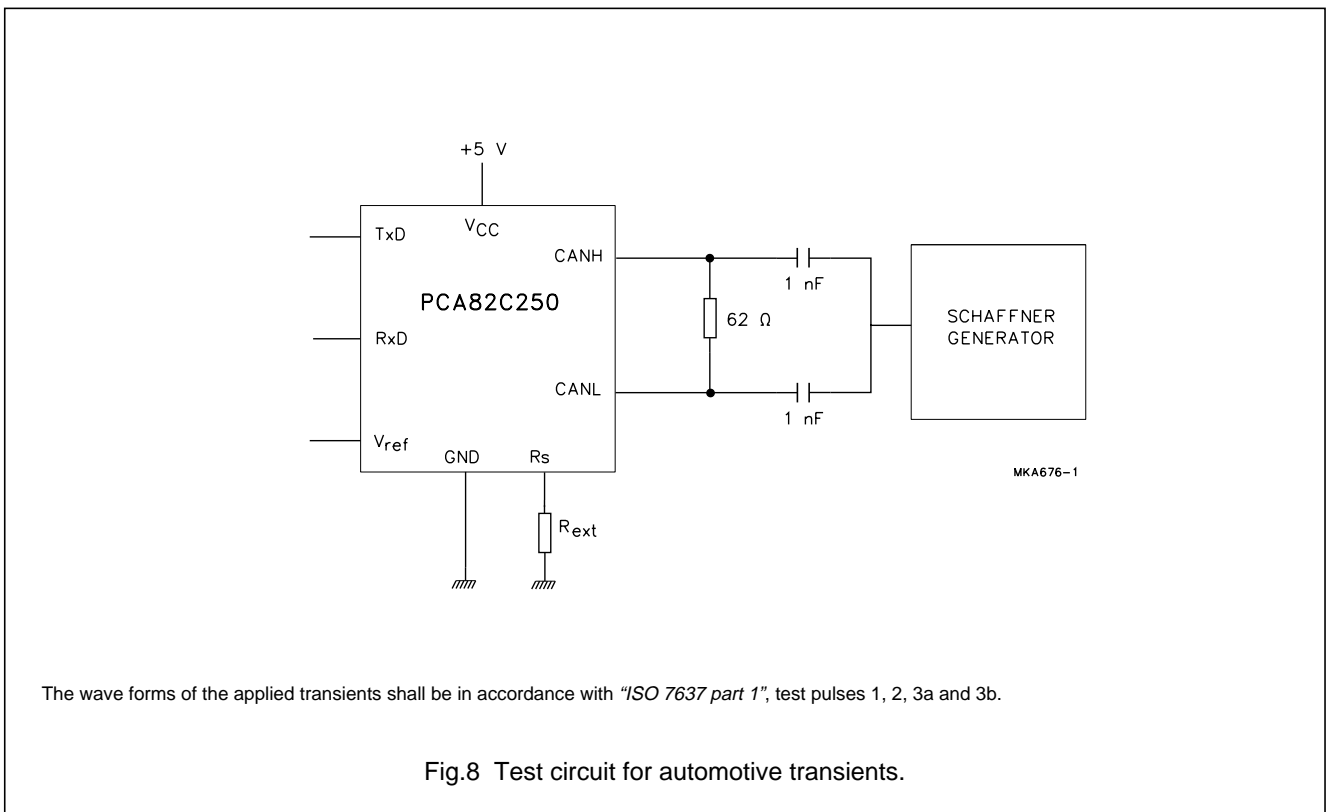
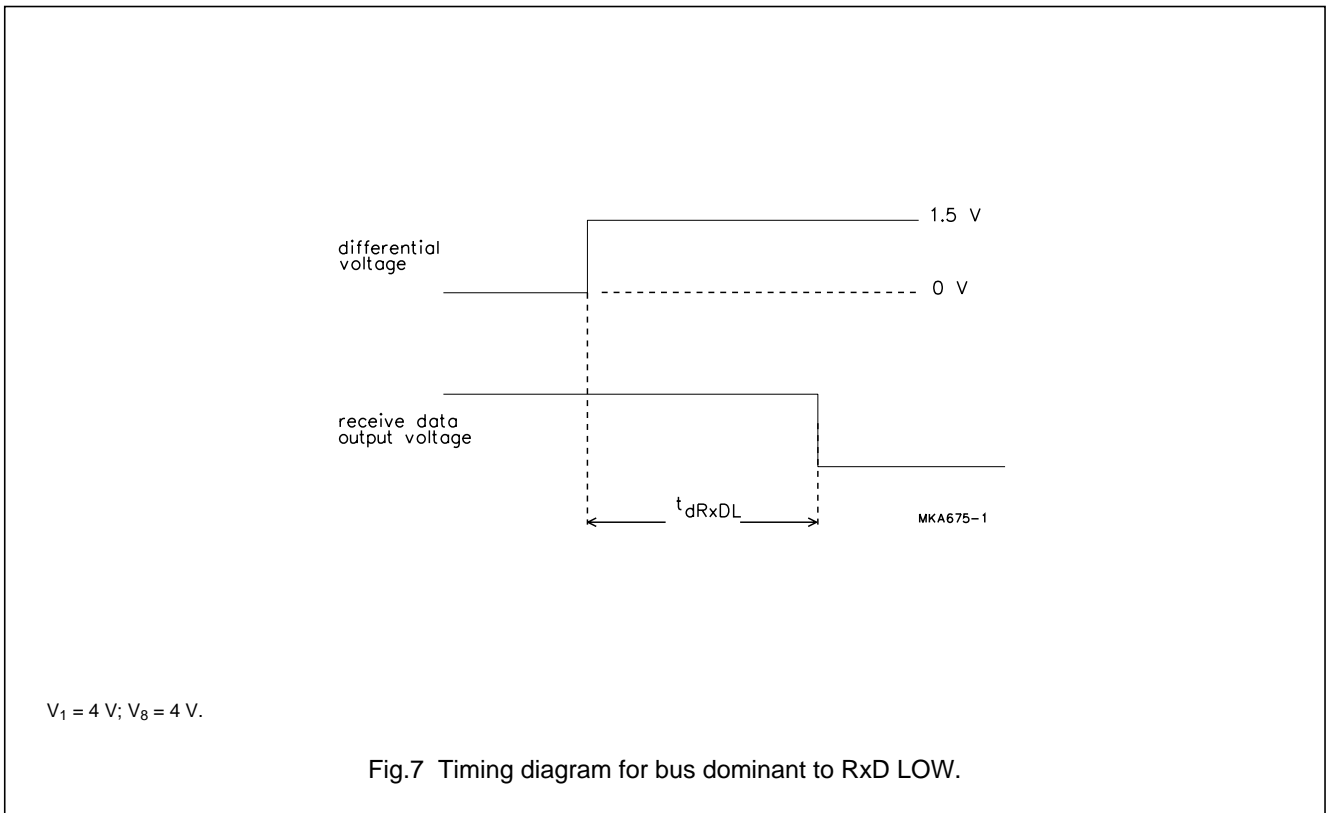


$V_1 = 1 V.$

Fig.6 Timing diagram for wake-up from standby.

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APPLICATION INFORMATION

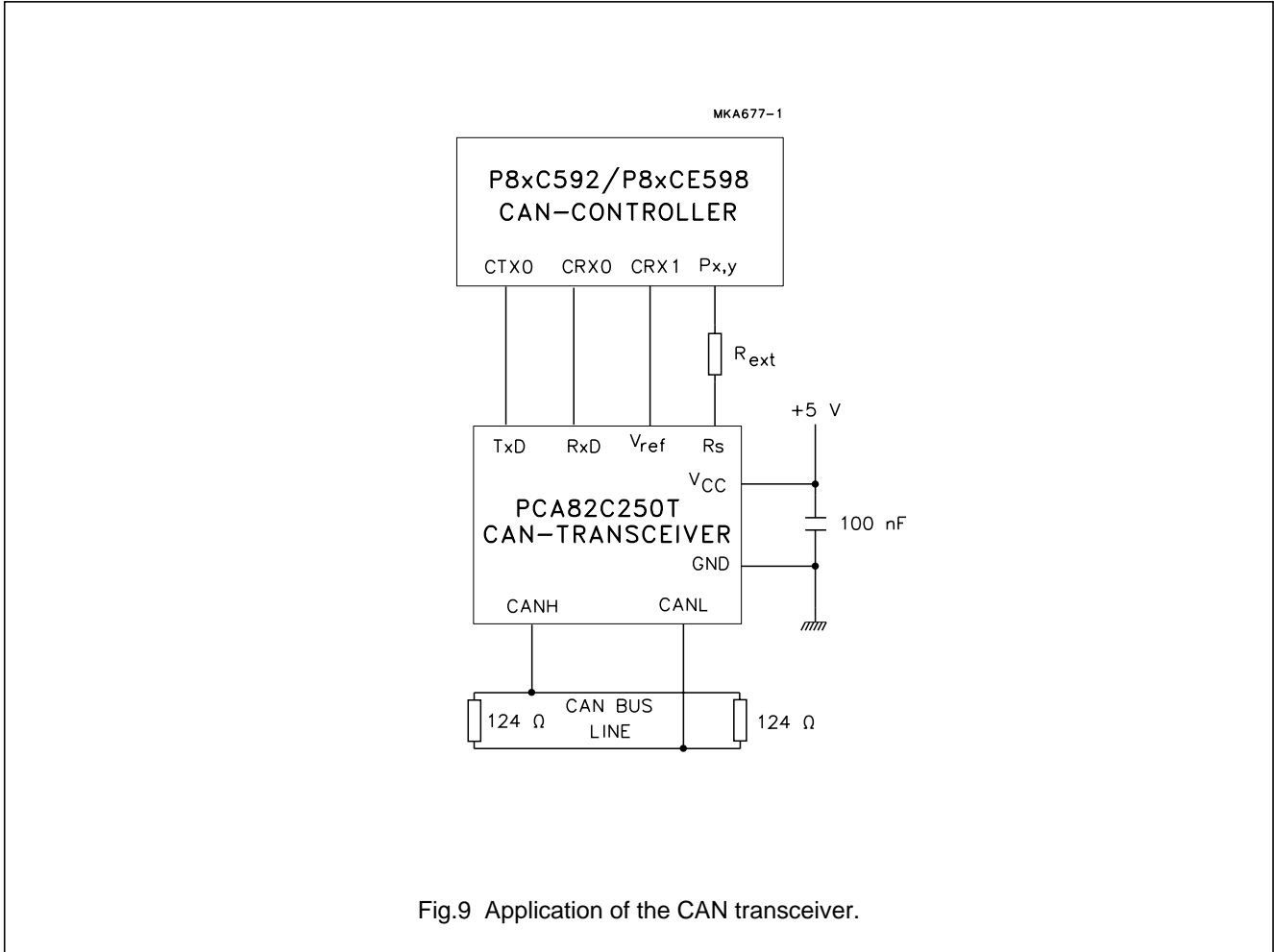


Fig.9 Application of the CAN transceiver.

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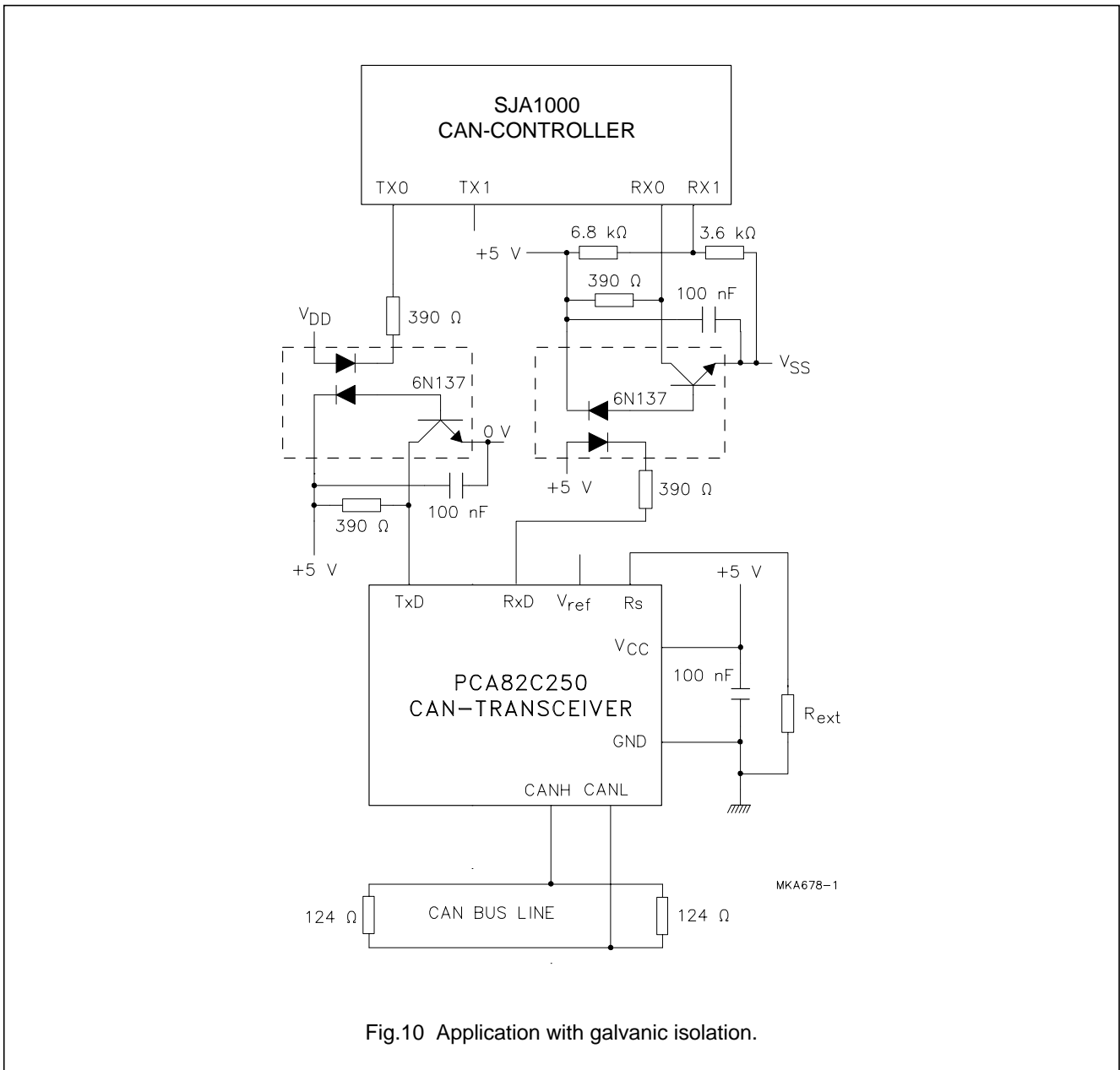


Fig.10 Application with galvanic isolation.

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INTERNAL PIN CONFIGURATION

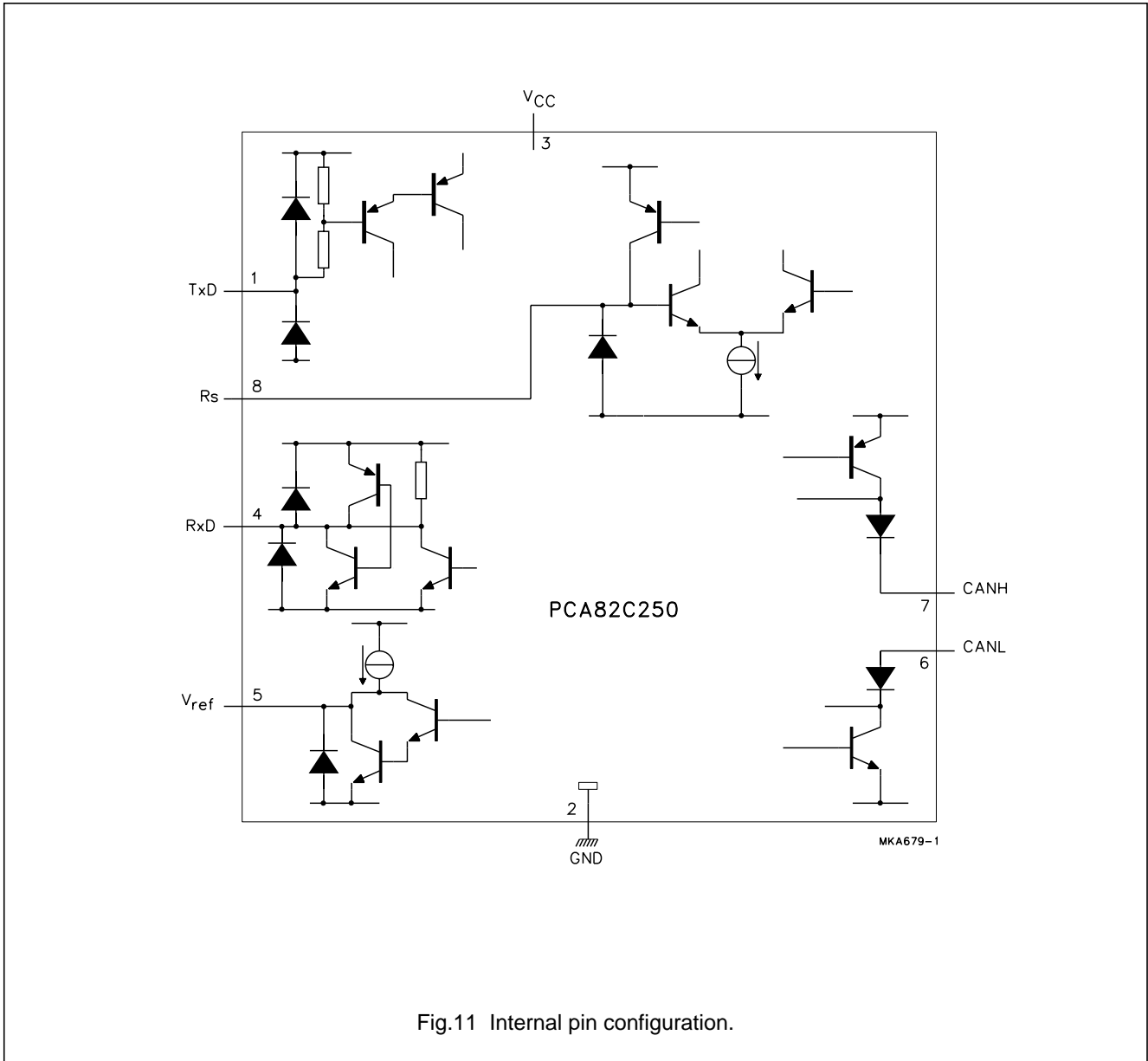


Fig.11 Internal pin configuration.

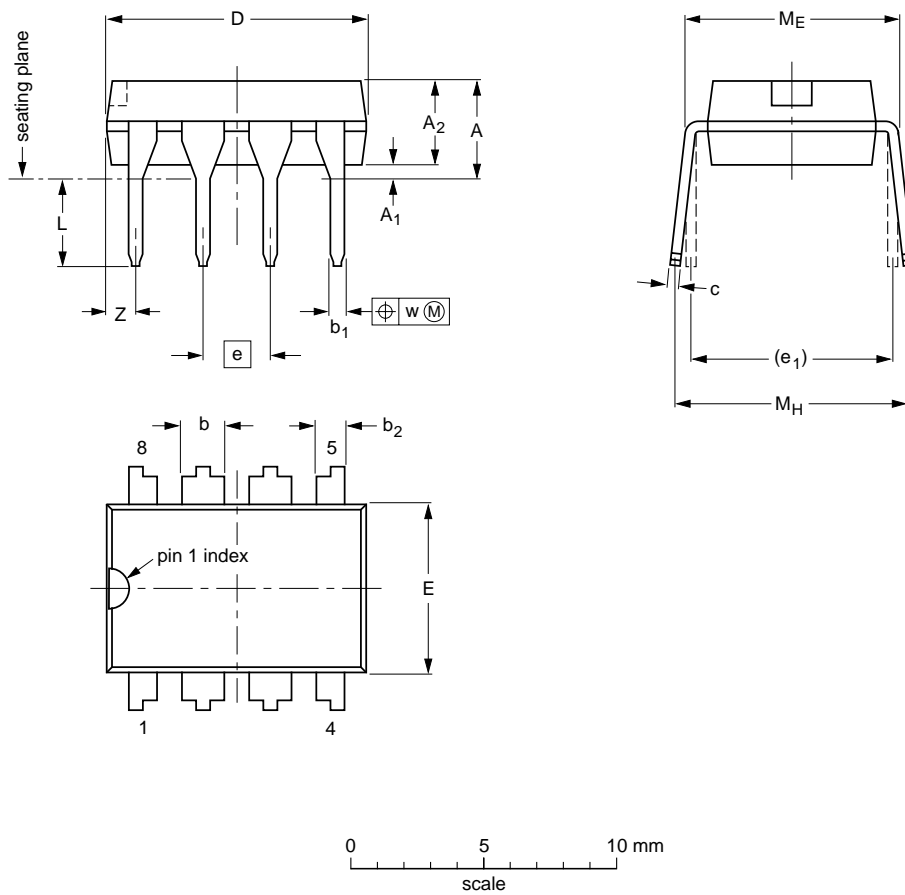
CAN controller interface

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PACKAGE OUTLINES

DIP8: plastic dual in-line package; 8 leads (300 mil)

SOT97-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | b ₂ | c | D ⁽¹⁾ | E ⁽¹⁾ | e | e ₁ | L | M _E | M _H | w | Z ⁽¹⁾ max. |
|--------|--------|---------------------|---------------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|----------------|----------------|-------|-----------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.14 | 0.53 0.38 | 1.07 0.89 | 0.36 0.23 | 9.8 9.2 | 6.48 6.20 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 1.15 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.045 | 0.021 0.015 | 0.042 0.035 | 0.014 0.009 | 0.39 0.36 | 0.26 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.045 |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

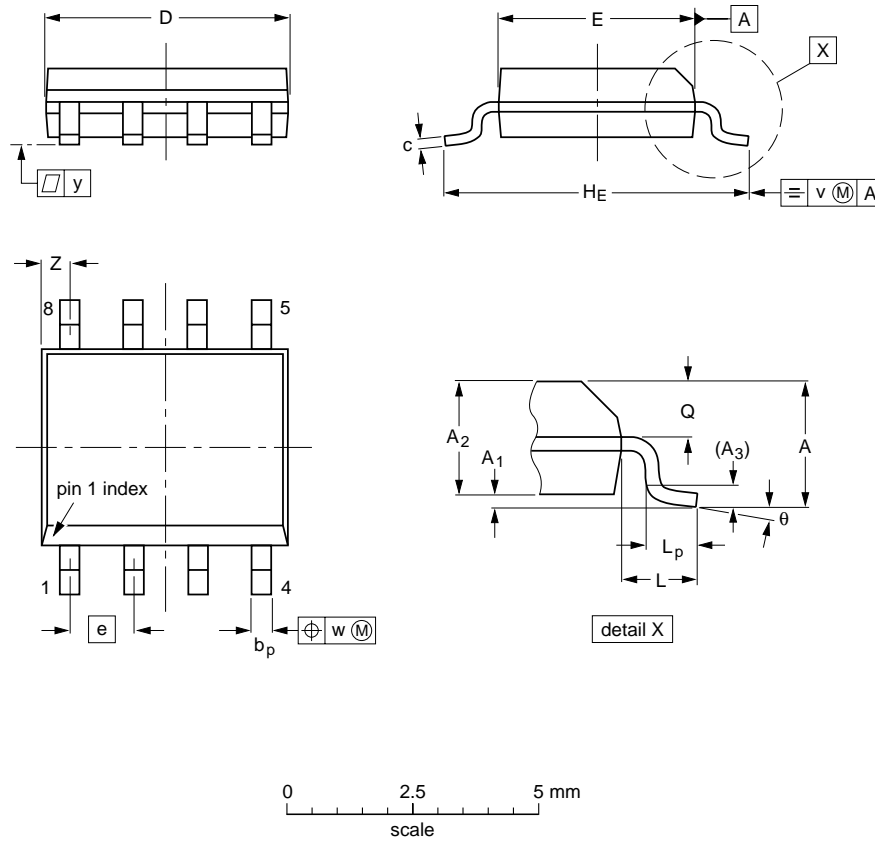
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT97-1 | 050G01 | MO-001AN | | | | 92-11-17 95-02-04 |

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S08: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | z ⁽¹⁾ | θ |
|--------|--------|----------------|----------------|----------------|----------------|------------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm | 1.75 | 0.25 0.10 | 1.45 1.25 | 0.25 | 0.49 0.36 | 0.25 0.19 | 5.0 4.8 | 4.0 3.8 | 1.27 | 6.2 5.8 | 1.05 | 1.0 0.4 | 0.7 0.6 | 0.25 | 0.25 | 0.1 | 0.7 0.3 | 8° 0° |
| inches | 0.069 | 0.010 0.004 | 0.057 0.049 | 0.01 | 0.019 0.014 | 0.0100 0.0075 | 0.20 0.19 | 0.16 0.15 | 0.050 | 0.244 0.228 | 0.041 | 0.039 0.016 | 0.028 0.024 | 0.01 | 0.01 | 0.004 | 0.028 0.012 | |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | |
| SOT96-1 | 076E03S | MS-012AA | | | 95-02-04 97-05-22 |

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SOLDERING**Introduction**

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

DIP

SOLDERING BY DIPPING OR BY WAVE

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg\ max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

SO

REFLOW SOLDERING

Reflow soldering techniques are suitable for all SO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

WAVE SOLDERING

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

REPAIRING SOLDERED JOINTS

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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DEFINITIONS

| Data sheet status | |
|---|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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NOTES

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NOTES

Philips Semiconductors – a worldwide company

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